## Electronic Acknowledgement Receipt FES ID: 1092550 Application Number: 10668558 Confirmation Number: 4709 Title of Invention: Nanometer-scale semiconductor devices and method of making First Named Inventor: James Stasiak HEWLETT-PACKARD COMPANY Intellectual Property Administration P. O. Box 272400 Correspondence Address: Fort Collins CO 80527-2400 US 5417151694 Filer: Donald James Coulman/Trisha Melcher Filer Authorized By: Donald James Coulman Attorney Docket Number: 100201346-5 Receipt Date: 26-JUN-2006 Filing Date: 22-SFP-2003 Time Stamp: 18:20:09 Application Type: Utility International Application Number: Payment information:

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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		100201346_5OAResp.pdf	321203	yes	8
	Multipart Description				
	Doc Desc		Start	End	
	Transmittal letter  Amendment After Final		1	1	
			2	3	
	Applicant Arguments/Remarks	Made in an Amendment	4	8	

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.